

Vishay Siliconix

RoHS

COMPLIANT HALOGEN

FREE

N-Channel 30 V (D-S) MOSFET

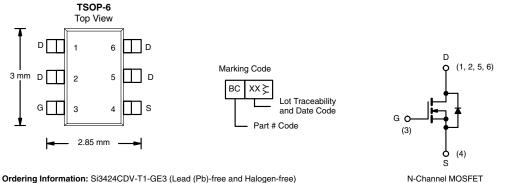
PRODUCT SUMMARY						
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A) ^{a, b}	Q _g (Typ.)			
30	0.026 at V _{GS} = 10 V	8	4.2			
	0.032 at V_{GS} = 4.5 V	8	4.2			

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFET
- 100 % Rg Tested
- Compliant to RoHS Directive 2002/95/EC •

APPLICATIONS

- Load Switch for Portable Devices
- **DC/DC** Converters •



N-Channel MOSFET

ABSOLUTE MAXIMUM RATING	S (T _A = 25 °C, un	less otherwise	e noted)		
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	30	v	
Gate-Source Voltage		V _{GS}	± 20	v	
	T _C = 25 °C		8 ^a		
Continuous Drain Current ($T_1 = 150 \ ^{\circ}C$)	T _C = 70 °C		7.7		
Commuted brain current $(T_j = 150^{\circ} C)$	T _A = 25 °C	I _D	7.2 ^{c, d}	A	
	T _A = 70 °C		5.7 ^{c, d}		
Pulsed Drain Current (t = 300 µs)		I _{DM}	I _{DM} 20		
Continuous Source-Drain Diode Current	T _C = 25 °C	1	3	•	
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	1.7 ^{c, d}	— A	
	T _C = 25 °C		3.6		
Maximum Davies Dissignation	T _C = 70 °C		2.3	10/	
Maximum Power Dissipation	T _A = 25 °C	P _D	2.0 ^{c, d}	W	
	T _A = 70 °C		1.3 ^{c, d}		
Operating Junction and Storage Temperature R	T _J , T _{stg}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Typical	Maximum	Unit			
Maximum Junction-to-Ambient ^e	t ≤ 5 s	R _{thJA}	50	62.5	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	28	35			

Notes:

a. Package limited.

b. Based on $T_C = 25$ °C.

c. Surface mounted on 1" x 1" FR4 board.

d. t = 5 s.

e. Maximum under steady state conditions is 110 °C/W.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static	-					
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA	30			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	1 050 11		28		mV/°C
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	- 3.7		
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	1		2.5	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V V _{DS} = 30 V, V _{GS} = 0 V, T _J = 85 °C			1 10	μA
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = \ge 5 V$, $V_{GS} = 10 V$	20			Α
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 7.2 \text{ A}$ $V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 6.5 \text{ A}$		0.021	0.026	Ω
Forward Transconductance	9 _{fs}	$V_{DS} = 15 \text{ V}, I_D = 7.2 \text{ A}$		17		S
Dynamic ^b	- 10		I	I	I	
Input Capacitance	C _{iss}			405		[
Output Capacitance	C _{oss}	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz		92		pF
Reverse Transfer Capacitance	C _{rss}			42		
Total Gate Charge	Qg	$V_{DC} = 15 V$, $V_{CC} = 10 V$, $I_{D} = 7.2 A$		8.3	12.5	
Total Gate Gharge				4.2	6.3	nC
Gate-Source Charge	Q _{gs}	V_{DS} = 24 V, V_{GS} = 4.5 V, I_{D} = 7.2 A		1.2		
Gate-Drain Charge	Q _{gd}			1.6		
Gate Resistance	R _g	f = 1 MHz	0.6	3	6	Ω
Turn-On Delay Time	t _{d(on)}			3	6	
Rise Time	t _r	V_{DD} = 15 V, R_L = 2.6 Ω		12	20	
Turn-Off DelayTime	t _{d(off)}	$I_D \cong 5.7 \text{ A}, \text{ V}_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$		16	24	
Fall Time	t _f			8	16	ns
Turn-On Delay Time	t _{d(on)}			10	20	- 115
Rise Time	t _r	V_{DD} = 15 V, R_L = 2.6 Ω		22	33	
Turn-Off DelayTime	t _{d(off)}	$I_{D} \cong 5.7 \text{ A}, \text{ V}_{\text{GEN}} = 4.5 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$		15	23	
Fall Time	t _f			9	18	
Drain-Source Body Diode Characteris	tics					
Continous Source-Drain Diode Current	I _S	T _C = 25 °C			3	А
Pulse Diode Forward Current ^a	I _{SM}				20	~
Body Diode Voltage	V _{SD}	I _S = 5.7 A		0.8	1.2	V
Body Diode Reverse Recovery Time	t _{rr}			13	20	nC
Body Diode Reverse Recovery Charge	Q _{rr}	$I_{-} = 5.7 \text{ A}$ dl/dt = 100 A/up		5	10	
Reverse Recovery Fall Time	t _a	$I_F = 5.7 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}$		8		ns
Reverse Recovery Rise Time	t _b			5		

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

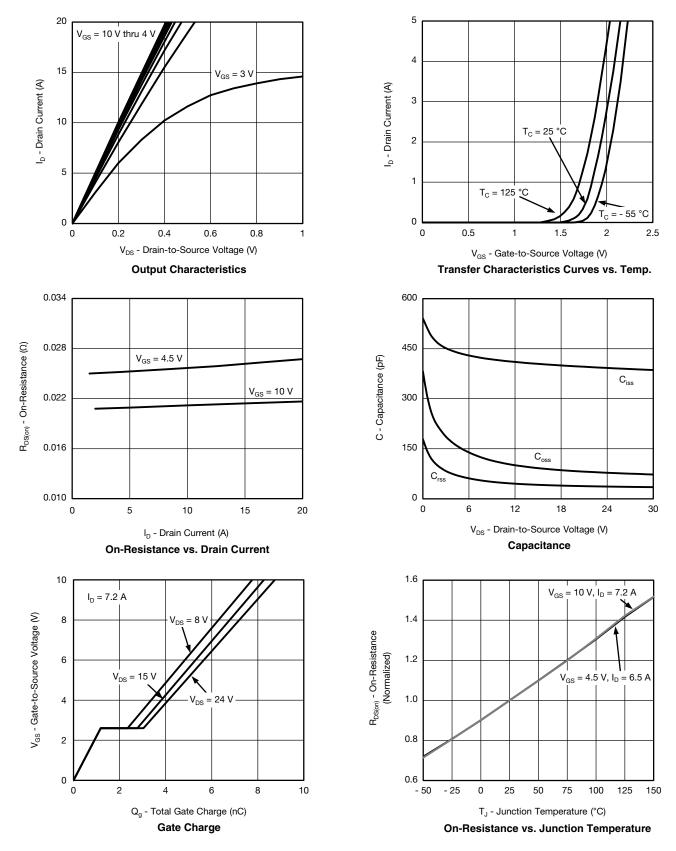
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



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TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



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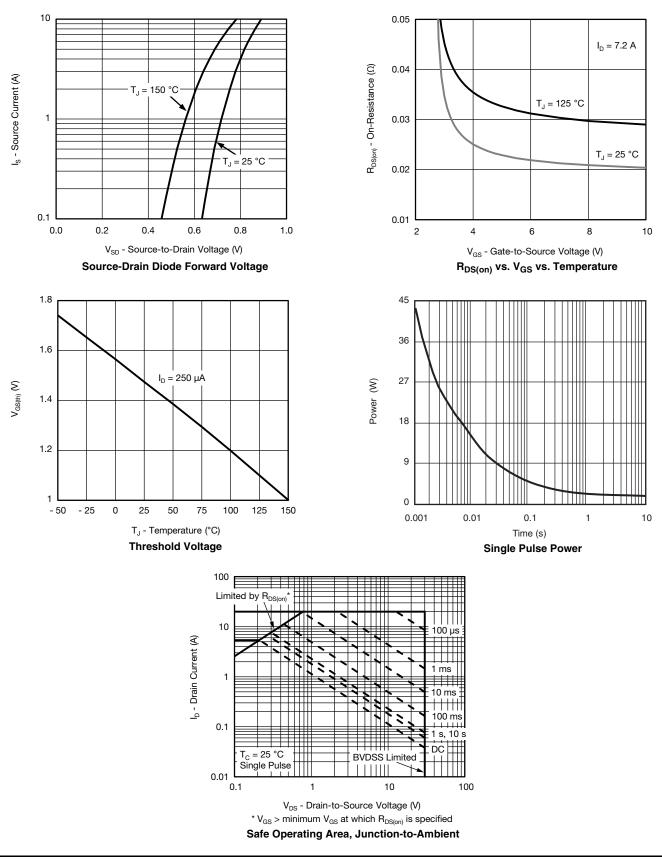
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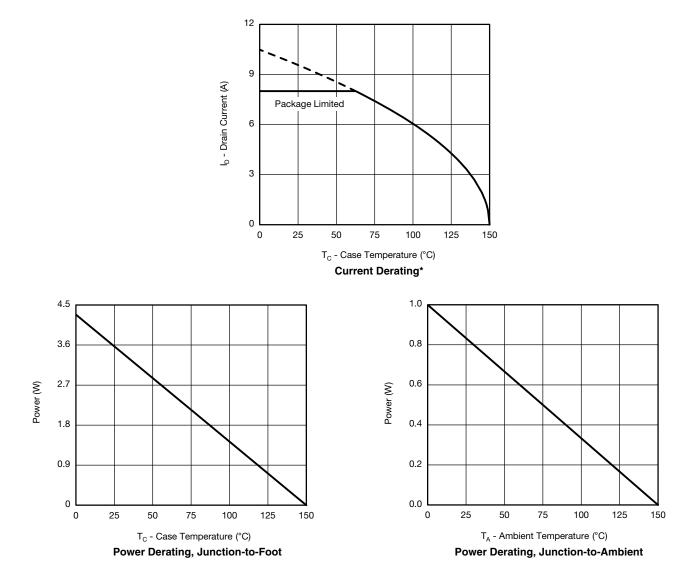


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TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



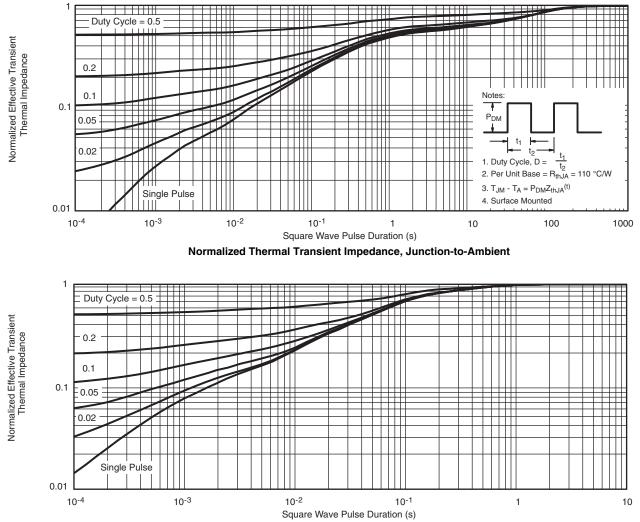
* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

Si3424CDV

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TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <u>www.vishay.com/ppg?67443</u>.

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Package Information

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TSOP: 5/6-LEAD JEDEC Part Number: MO-193C









6-LEAD TSOP



	MILLIMETERS			INCHES			
Dim	Min	Nom	Max	Min	Nom	Max	
Α	0.91	-	1.10	0.036	-	0.043	
A ₁	0.01	-	0.10	0.0004	-	0.004	
A ₂	0.90	-	1.00	0.035	0.038	0.039	
b	0.30	0.32	0.45	0.012	0.013	0.018	
С	0.10	0.15	0.20	0.004	0.006	0.008	
D	2.95	3.05	3.10	0.116	0.120	0.122	
Е	2.70	2.85	2.98	0.106	0.112	0.117	
E ₁	1.55	1.65	1.70	0.061	0.065	0.067	
е	0.95 BSC			0.0374 BSC			
e ₁	1.80	1.90	2.00	0.071	0.075	0.079	
L	0.32	-	0.50	0.012	-	0.020	
L ₁		0.60 Ref		0.024 Ref			
L ₂	0.25 BSC			0.010 BSC			
R	0.10	-	-	0.004	-	-	
θ	0°	4°	8°	0°	4°	8°	
θ_1	7° Nom			7° Nom			
ECN: C-06593-Rev. I, 18-Dec-06 DWG: 5540							



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